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Automotive N-Channel 72 V (D-S) 175 °C MOSFET

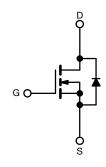


Marking code: Q079

PRODUCT SUMMARY			
V _{DS} (V)	72		
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 V$	0.0095		
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 V$	0.0120		
I _D (A) ^a	54		
Configuration	Single		

FEATURES

- TrenchFET[®] Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % R_g and UIS tested
- Wettable flank terminals
- Low thermal resistance with 0.75 mm profile
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



N-Channel MOSFET

ORDERING INFORMATION				
Package	PowerPAK [®] 1212-8SLW			
Lead (Pb)-free and halogen-free	SQS178ELNW (for detailed order number please see <u>www.vishay.com/doc?79771</u>)			

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	72		
Gate-source voltage		V _{GS}	± 20	V	
Continuous drain current ^a	$T_{\rm C} = 25 ^{\circ}{\rm C}$				
$T_{C} = 125 \text{ °C}$ Continuous source current (diode conduction) ^a		I _S	31 59	А	
Pulsed drain current ^{a, b}		I _{DM}	115		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	21		
Single pulse avalanche energy	L = 0.1 MH	E _{AS}	22	mJ	
Maximum power dissipation ^{a, b}	$T_{C} = 25 \text{ °C}$ $T_{C} = 125 \text{ °C}$	P _D	65 21	W	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	ŝ	
Soldering recommendations (peak temperatur		260	°C		
THERMAL RESISTANCE RATING	S				
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount ^d	R _{thJA}	54	0044	
Junction-to-case (drain) ^e		R _{thJC}	2.3	°C/W	

Notes

a. Values based on R_{thJC} and T_C of 25 °C. Actual values achievable will be dependent on the thermal characteristics of the complete system

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

c. See solder profile (<u>www.vishay.com/doc?73257</u>). A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

d. When mounted on 1" square PCB (FR4 material)

e. As per on JESD51-14

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•			·	·	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0, I_D = 250 \ \mu A$		72	-	-	v
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$		1.2	1.7	2.5	v
Gate-source leakage	I _{GSS}	V _{DS} =	0 V, $V_{GS} = \pm 20 V$	-	-	± 100	nA
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 72 V	-	-	1	
		$V_{GS} = 0 V$	V_{DS} = 72 V, T_J = 125 °C	-	-	50	μA
		$V_{GS} = 0 V$	$V_{DS} = 72 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$	-	-	150	
On-state drain current ^a	I _{D(on)}	$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	20	-	-	А
		V _{GS} = 4.5 V	10.4	-	0.0095	0.012	
	P	V _{GS} = 10 V	I _D = 10 A	-	0.007	0.0095	
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 10 V	I _D = 10 A, T _J = 125 °C	-	-	0.0178	Ω
		V _{GS} = 10 V	I _D = 10 A, T _J = 175 °C	-	-	0.0220	1
Forward transconductance b	g _{fs}	V _{DS}	= 15 V, I _D = 55 A	-	76	-	S
Dynamic ^b		•			•		
Input capacitance	C _{iss}		V _{DS} = 25 V, f = 1 MHz	-	1522	2131	pF
Output capacitance	C _{oss}	$V_{GS} = 0 V$		-	264	370	
Reverse transfer capacitance	C _{rss}			-	9	15	
Total gate charge ^c	Qg			-	26	39	1
Gate-source charge ^c	Q _{gs}	V _{GS} = 10 V V _{DS} = 36 V, I _D = 4 A	-	5	-	nC	
Gate-drain charge ^c	Q _{gd}			-	5		-
Gate resistance	R _g		f = 1 MHz	0.3	1.0	1.6	Ω
Turn-on delay time ^c	t _{d(on)}			-	10	15	
Rise time ^c	t _r	V _{DD} =	36 V, R _I = 14.4 Ω,	-	3	6	
Turn-off delay time ^c	t _{d(off)}	$I_D \cong 2.5 \text{ A}, V_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$		-	23	35	- ns
Fall time ^c	t _f			-	9	14	
Source-Drain Diode Ratings and Charac	teristic ^b	•			·		
Pulsed current ^a	I _{SM}			-	-	115	Α
Forward voltage	V_{SD}	I _F = 10 A, V _{GS} = 0 V		-	0.82	1.1	V
Body diode reverse recovery time	t _{rr}	V _{DD} = 58 V, I _{FM} = 3.5 A, di/dt = 100 A/μs, R = 10 Ω, L = 0.3 mH, pulse width = 2 μs		-	30	60	ns
Body diode reverse recovery charge	Q _{rr}			-	23	46	nC
Reverse recovery fall time	t _a			-	15	-	
Reverse recovery rise time	t _b			-	15	-	ns
Body diode peak reverse recovery current	I _{RM(REC)}			-	-1.3	_	А

Notes

a. Pulse test; pulse width $\leq 300~\mu\text{s},$ duty cycle $\leq 2~\%$

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

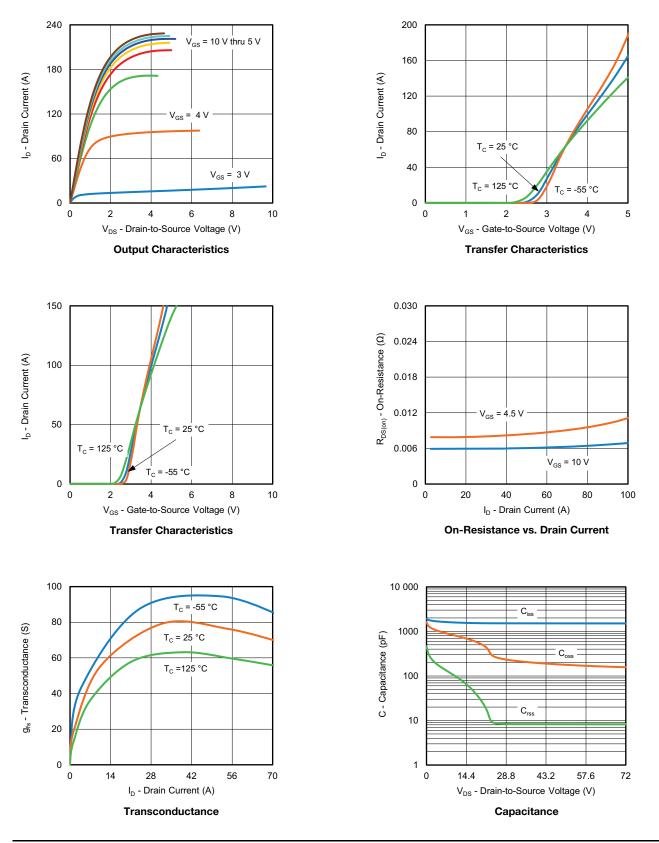
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



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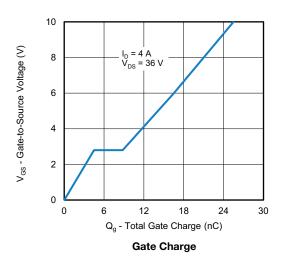
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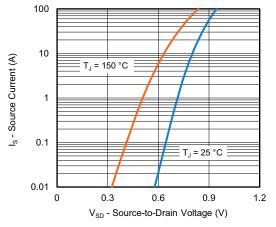
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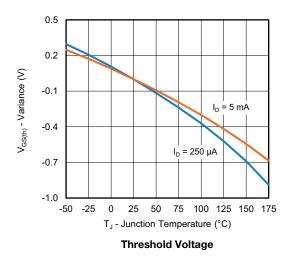
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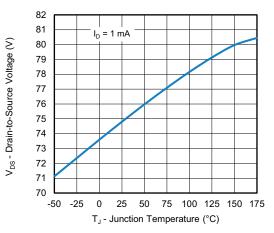
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



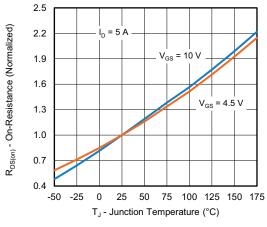


Source Drain Diode Forward Voltage

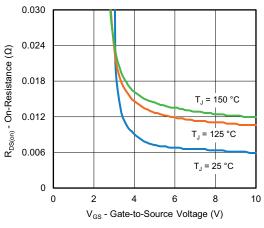




Drain Source Breakdown vs. Junction Temperature



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

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tiona contact: automostochouppo

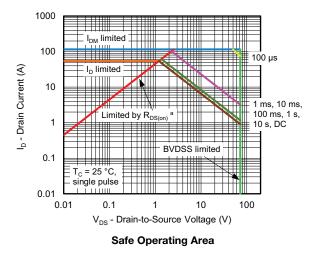
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THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)

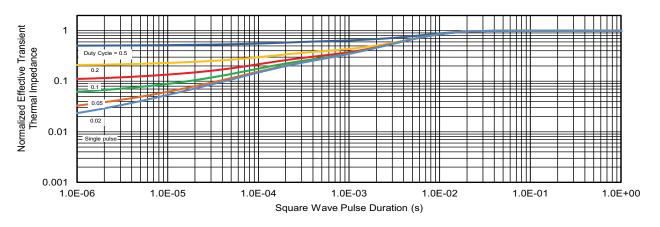


Note

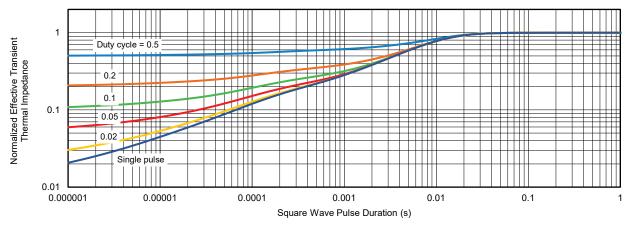
a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified



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Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62194.

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